

# DATA SHEET

## **74AC125/74ACT125** Quad buffer/line driver (3-state)

Product specification

1997 May 15

## Quad buffer/line driver (3-state)

74AC125  
74ACT125

## FEATURES

- 74ACT125 has TTL-compatible inputs
- 74AC125 has CMOS-compatible inputs
- 3-State outputs source/sink 24mA
- 3-State outputs drive bus lines or buffer memory address registers
- Meets or exceeds JEDEC standard standard for 74AC(T)XX family

## DESCRIPTION

The 74AC125/74ACT125 is a high-performance, low-power, low-voltage, Si-gate CMOS device and superior to most advanced CMOS compatible TTL families.

The 74AC125/74ACT125 consists of four independent non-inverting buffers/line drivers with 3-state outputs. The 3-state outputs (nY) are controlled by the associated output enable input (nOE). A HIGH at nOE causes the outputs to assume a high impedance OFF-state.

## QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYPICAL			UNIT
			AC		ACT	
			V <sub>CC</sub> = 3.3V	V <sub>CC</sub> = 5.0V	V <sub>CC</sub> = 5.0V	
t <sub>PHL</sub> /t <sub>PLH</sub>	Propagation delay nA to nY	C <sub>L</sub> = 50pF V <sub>CC</sub> = 3.3V	3.4	2.4	3.8	ns
C <sub>I</sub>	Input capacitance		4.5			pF
C <sub>PD</sub>	Power dissipation capacitance per buffer	V <sub>I</sub> = GND to V <sub>CC</sub> <sup>1</sup> outputs enabled outputs disabled	22 5		18 3	pF

## NOTE:

1. C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW):

$$P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f<sub>i</sub> = input frequency in MHz; C<sub>L</sub> = output load capacity in pF;

f<sub>o</sub> = output frequency in MHz; V<sub>CC</sub> = supply voltage in V;

∑ (C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) = sum of outputs.

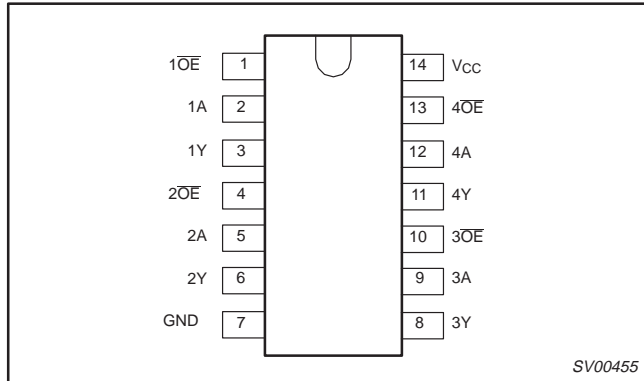
## ORDERING AND PACKAGE INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DRAWING NUMBER
14-Pin Plastic SOL	-40°C to +85°C	74AC125D 74ACT125D	74AC125D 74ACT125D	SOT108-1
14-Pin Plastic SSOP Type II	-40°C to +85°C	74AC125DB 74ACT125DB	74AC125DB 74ACT125DB	SOT337-1
14-Pin Plastic TSSOP Type I	-40°C to +85°C	74AC125PW 74ACT125PW	74AC125PW DH 74ACT125PW DH	SOT402-1

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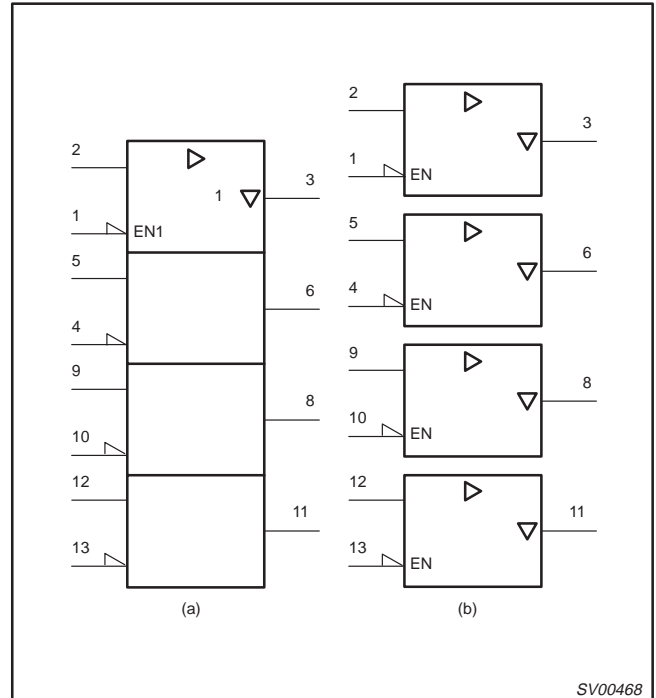
## PIN CONFIGURATION



## PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 4, 10, 13	$\overline{1OE}$ to $\overline{4OE}$	Data enable inputs (active LOW)
2, 5, 9, 12	1A to 4A	Data inputs
3, 6, 8, 11	1Y to 4Y	Data Outputs
7	GND	Ground (0 V)
14	V <sub>CC</sub>	Positive supply voltage

## LOGIC SYMBOL (IEEE/IEC)

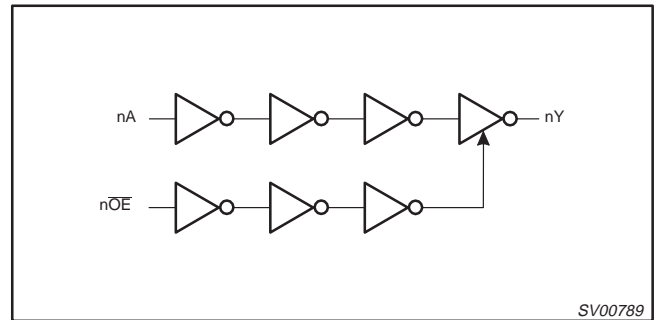


## FUNCTION TABLE

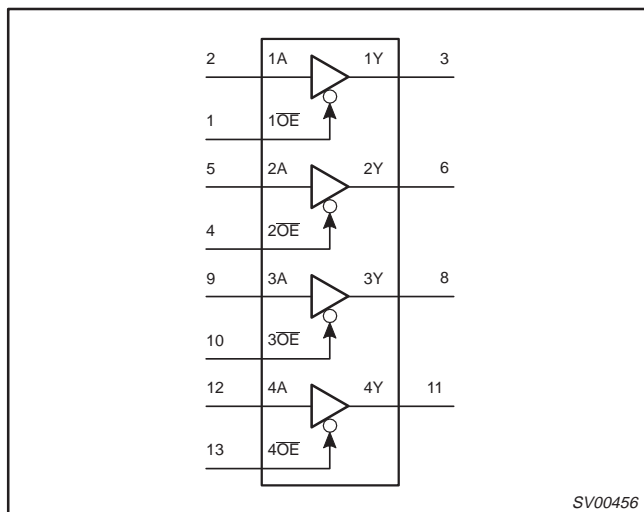
INPUTS		OUTPUT
$n\overline{OE}$	nA	nY
L	L	L
L	H	H
H	X	Z

H = HIGH voltage level  
L = LOW voltage level  
X = don't care  
Z = high impedance OFF-state

## LOGIC DIAGRAM



## LOGIC SYMBOL



## Quad buffer/line driver (3-state)

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74ACT125

## RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS		UNIT
		MIN	MAX	
$V_{CC}$	DC supply voltage for 'AC	2.0	6.0	V
$V_{CC}$	DC supply voltage for 'ACT	4.5	5.5	V
$V_{IN}$	DC input voltage range	0	$V_{CC}$	V
$V_O$	DC output voltage range	0	$V_{CC}$	V
$T_{amb}$	Operating free-air temperature range	-40	+85	°C
$\Delta V/\Delta t$	Minimum input edge rate — AC devices $V_{IN}$ from 30% to 70% of $V_{CC}$ $V_{CC}$ @ 3.3V, 4.5V, 5.5V	125		mV/ns
	— ACT devices $V_{IN}$ from 0.8V to 2.0V $V_{CC}$ @ 4.5V, 5.5V	125		

ABSOLUTE MAXIMUM RATINGS<sup>1</sup>

in accordance with the Absolute Maximum Rating System (IEC134)  
Voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
$V_{CC}$	DC supply voltage		-0.5 to +7.0	V
$I_{IK}$	DC input diode current	$V_{IN} = -0.5V$	-20	mA
		$V_{IN} = V_{CC} + 0.5V$	+20	
$V_{IN}$	DC input voltage		-0.5 to $V_{CC} + 0.5$	V
$I_{OK}$	DC output diode current	$V_O = -0.5V$	-20	mA
		$V_O = V_{CC} + 0.5V$	+20	
$V_O$	DC output voltage		-0.5 to $V_{CC} + 0.5$	V
$I_O$	DC output source or sink current		± 50	mA
$I_{CC}, I_{GND}$	DC $V_{CC}$ or GND current per output		± 50	mA
$I_{CC}, I_{GND}$	DC $V_{CC}$ or GND current		± 200	mA
$T_{stg}$	Storage temperature range		-65 to 150	°C
$P_{TOT}$	Power dissipation per package — plastic mini-pack (SO) — plastic shrink mini-pack (SSOP and TSSOP)	above +70°C derate linearly with 8 mW/K	500	mW
		above +60°C derate linearly with 5.5 mW/K	500	

## NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## Quad buffer/line driver (3-state)

74AC125  
74ACT125**DC ELECTRICAL CHARACTERISTICS (74AC125)**

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	TEST CONDITIONS	V <sub>CC</sub> (V)	LIMITS			UNIT	
				Temp = -40°C to +85°C				
				MIN	TYP <sup>1</sup>	MAX		
V <sub>IH</sub>	HIGH level Input voltage	V <sub>OUT</sub> = 0.1V or (V <sub>CC</sub> - 0.1V)	3.0	2.1	1.5		V	
			4.5	3.15	2.25			
			5.5	3.85	2.75			
V <sub>IL</sub>	LOW level Input voltage	V <sub>OUT</sub> = 0.1V or (V <sub>CC</sub> - 0.1V)	3.0		1.5	0.9	V	
			4.5		2.25	1.35		
			5.5		2.75	1.65		
V <sub>OH</sub>	HIGH level output voltage	I <sub>OUT</sub> = -50 μA	3.0	2.9	2.99		V	
			4.5	4.4	4.49			
			5.5	5.4	5.49			
			V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> , I <sub>OH</sub> = -12mA <sup>1</sup>	3.0	2.46			V
			V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> , I <sub>OH</sub> = -24mA <sup>1</sup>	4.5	3.76			
			V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> , I <sub>OH</sub> = -24mA <sup>1</sup>	5.5	4.76			
V <sub>OL</sub>	LOW level output voltage	I <sub>OUT</sub> = 50 μA	3.0		0.01	0.1	V	
			4.5		0.01	0.1		
			5.5		0.01	0.1		
			V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> , I <sub>OL</sub> = 12mA <sup>1</sup>	3.0			0.44	V
			V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> , I <sub>OL</sub> = 24mA <sup>1</sup>	4.5			0.44	
			V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> , I <sub>OL</sub> = 24mA <sup>1</sup>	5.5			0.44	
I <sub>IN</sub>	Input leakage current	V <sub>IN</sub> = V <sub>CC</sub> , GND	5.5			±1.0	μA	
I <sub>OZ</sub>	3-State output OFF-state current	V <sub>IN</sub> (OE) = V <sub>IL</sub> , V <sub>IH</sub> V <sub>IN</sub> = V <sub>CC</sub> , GND V <sub>OUT</sub> = V <sub>CC</sub> , GND	5.5			±2.5	μA	
I <sub>OLD</sub> <sup>2</sup>	Dynamic output current <sup>2</sup>	V <sub>OLD</sub> = 1.65V max	5.5	75			mA	
I <sub>OHD</sub> <sup>2</sup>	Dynamic output current <sup>2</sup>	V <sub>OHD</sub> = 3.85V min	5.5			-75	mA	
I <sub>CC</sub>	Quiescent supply current	V <sub>IN</sub> = V <sub>CC</sub> or GND	5.5			40	μA	

**NOTES:**

- All outputs loaded
- Maximum test duration 2.0 ms; one output loaded at a time

## Quad buffer/line driver (3-state)

74AC125  
74ACT125**DC ELECTRICAL CHARACTERISTICS (74ACT125)**

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	TEST CONDITIONS	V <sub>CC</sub> (V)	LIMITS			UNIT
				Temp = -40°C to +85°C			
				MIN	TYP <sup>1</sup>	MAX	
V <sub>IH</sub>	HIGH level Input voltage	V <sub>OUT</sub> = 0.1V or (V <sub>CC</sub> - 0.1V)	4.5	2.0	1.5		V
			5.5	2.0	1.5		
V <sub>IL</sub>	LOW level Input voltage	V <sub>OUT</sub> = 0.1V or (V <sub>CC</sub> - 0.1V)	4.5		1.5	0.8	V
			5.5		1.5	0.8	
V <sub>OH</sub>	HIGH level output voltage	I <sub>OUT</sub> = -50 μA	4.5	4.4	4.49		V
			5.5	5.4	5.49		
		V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> , I <sub>OH</sub> = -24mA <sup>1</sup>	4.5	3.76			V
		V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> , I <sub>OH</sub> = -24mA <sup>1</sup>	5.5	4.76			
V <sub>OL</sub>	LOW level output voltage	I <sub>OUT</sub> = 50 μA	4.5		0.01	0.1	V
			5.5		0.01	0.1	
		V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> , I <sub>OL</sub> = 24mA <sup>1</sup>	4.5			0.44	V
		V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> , I <sub>OL</sub> = 24mA <sup>1</sup>	5.5			0.44	
I <sub>IN</sub>	Input leakage current	V <sub>IN</sub> = V <sub>CC</sub> , GND	5.5			±1.0	μA
I <sub>OZ</sub>	3-State output OFF-state current	V <sub>IN</sub> (OE) = V <sub>IL</sub> , V <sub>IH</sub> V <sub>IN</sub> = V <sub>CC</sub> , GND V <sub>OUT</sub> = V <sub>CC</sub> , GND	5.5			±2.5	μA
ΔI <sub>CC</sub>	Additional quiescent supply current per input pin	V <sub>IN</sub> = V <sub>CC</sub> - 2.1V Other inputs at V <sub>CC</sub> or GND; I <sub>OUT</sub> = 0	5.5			1.5	mA
I <sub>OLD</sub> <sup>2</sup>	Dynamic output current	V <sub>OLD</sub> = 1.65V max	5.5	75			mA
I <sub>OHD</sub> <sup>2</sup>	Dynamic output current	V <sub>OHD</sub> = 3.85V min	5.5			-75	mA
I <sub>CC</sub>	Quiescent supply current	V <sub>IN</sub> = V <sub>CC</sub> or GND	5.5			40	μA

**NOTES:**

1. All outputs loaded
2. Maximum test duration 2.0ms, one output loaded at a time

## Quad buffer/line driver (3-state)

74AC125  
74ACT125**AC CHARACTERISTICS FOR 74AC125**GND = 0V;  $t_r = t_f = 2.5\text{ns}$ ;  $C_L = 50\text{pF}$ ;  $R_L = 500\Omega$ ; .

SYMBOL	PARAMETER	$V_{CC}^1$ (V)	LIMITS					UNIT	WAVEFORM
			$T_{amb} = +25^\circ\text{C}$			$T_{amb} = -40^\circ\text{C to } +85^\circ\text{C}$			
			MIN	TYP	MAX	MIN	MAX		
$t_{PLH}$	Propagation delay nA to nY	3.3 5.0	2.0 1.5	3.4 2.4	9.0 6	1.5 1.0	10 7	ns	1, 3
$t_{PHL}$	Propagation delay nA to nY	3.3 5.0	2.0 1.5	3.4 2.5	9.0 6	1.5 1.0	10 7	ns	1, 3
$t_{PZH}$	3-State output enable time nOE to nY	3.3 5.0	2.0 1.5	4.3 2.9	9.5 6.5	1.5 1.0	11 7.5	ns	2, 3
$t_{PZL}$	3-State output enable time nOE to nY	3.3 5.0	2.0 1.5	4.7 3.2	9.5 6.5	1.5 1.0	11 7.5	ns	2, 3
$t_{PHZ}$	3-State output disable time nOE to nY	3.3 5.0	2.0 1.5	4.4 2.9	9.0 6	1.5 1.0	10 7	ns	2, 3
$t_{PLZ}$	3-State output disable time nOE to nY	3.3 5.0	2.0 1.5	4.2 3.0	9.0 6	1.5 1.0	10 7	ns	2, 3

**NOTE:**

1. Voltage range 3.3V is  $V_{CC} = 3.3\text{V} \pm 0.3\text{V}$   
Voltage range 5.0V is  $V_{CC} = 5.0\text{V} \pm 0.5\text{V}$

**AC CHARACTERISTICS FOR 74ACT125**GND = 0V;  $t_r = t_f = 2.5\text{ns}$ ;  $C_L = 50\text{pF}$ ;  $R_L = 500\Omega$ ; .

SYMBOL	PARAMETER	$V_{CC}^1$ (V)	LIMITS					UNIT	WAVEFORM
			$T_{amb} = +25^\circ\text{C}$			$T_{amb} = -40^\circ\text{C to } +85^\circ\text{C}$			
			MIN	TYP	MAX	MIN	MAX		
$t_{PLH}$	Propagation delay nA to nY	5.0	2.0	4.4	9.0	1.5	10	ns	1, 3
$t_{PHL}$	Propagation delay nA to nY	5.0	2.0	3.3	9.0	1.5	10	ns	1, 3
$t_{PZH}$	3-State output enable time nOE to nY	5.0	2.0	3.7	8.5	1.5	9.5	ns	2, 3
$t_{PZL}$	3-State output enable time nOE to nY	5.0	2.0	4	8.5	1.5	9.5	ns	2, 3
$t_{PHZ}$	3-State output disable time nOE to nY	5.0	2.0	4	8.0	1.5	9	ns	2, 3
$t_{PLZ}$	3-State output disable time nOE to nY	5.0	2.0	3.8	8.0	1.5	9	ns	2, 3

**NOTE:**

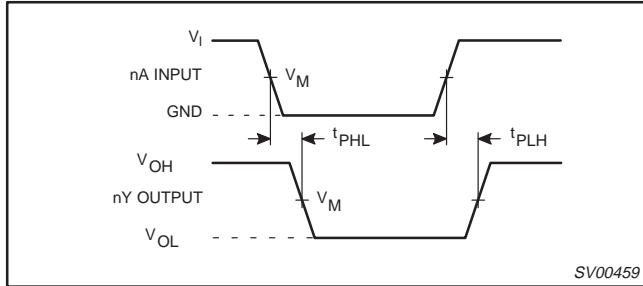
1. Voltage range 5.0V is  $V_{CC} = 5.0\text{V} \pm 0.5\text{V}$

# Quad buffer/line driver (3-state)

74AC125  
74ACT125

## AC WAVEFORMS

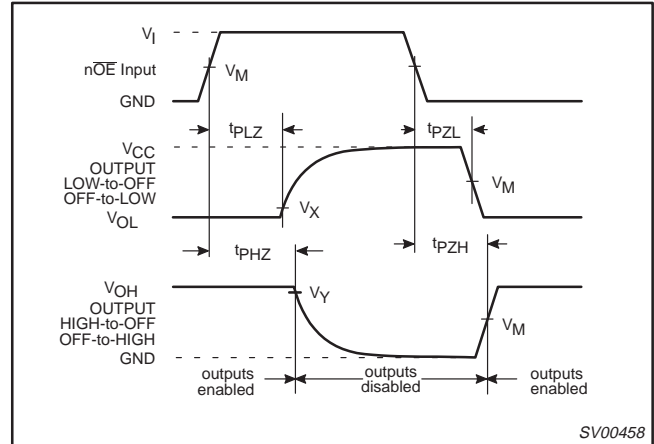
$V_m = 50\% V_{CC}$  for 'AC' devices; 1.5V for 'ACT' devices  
 $V_m = 50\% V_{CC}$  for 'AC'/'ACT' devices



Waveform 1. Input (nA) to output (nY) propagation delays and output transition times.

$V_{OL}$  and  $V_{OH}$  are the typical output voltage drops that occur with the output load.

$V_X = V_{OL} + 0.3V$   
 $V_Y = V_{OH} - 0.3V$



Waveform 2. 3-state enable and disable times.

## TEST CIRCUIT

Test Circuit for 3-State Outputs

SWITCH POSITION		FAMILY	VIN Input Requirements	Vm Input	Vm Output
TEST	SWITCH				
tPLH/tPHL	Open	AC	GND to VCC	50% VCC	50% VCC
tPLZ/tPZL	2 x VCC				
tPHZ/tPZH	Open	ACT	GND to 3.0V	1.5V	50% VCC

**DEFINITIONS**

$R_L$  = Load resistor; see AC CHARACTERISTICS for value.  
 $C_L$  = Load capacitance, see AC characteristics  
 $R_T$  = Termination resistance should be equal to  $Z_{OUT}$  of pulse generators.

Waveform 3. Load circuitry for switching times.

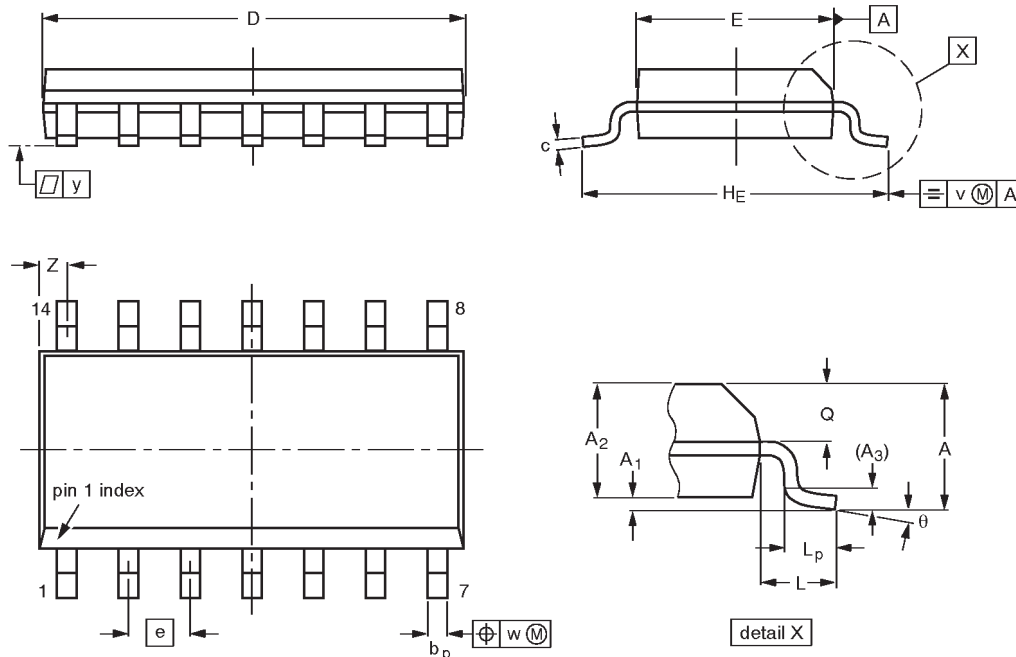


Quad buffer/line driver; (3-state)

74AC125  
74ACT125

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069	0.0098 0.0039	0.057 0.049	0.01	0.019 0.014	0.0098 0.0075	0.35 0.34	0.16 0.15	0.050	0.24 0.23	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

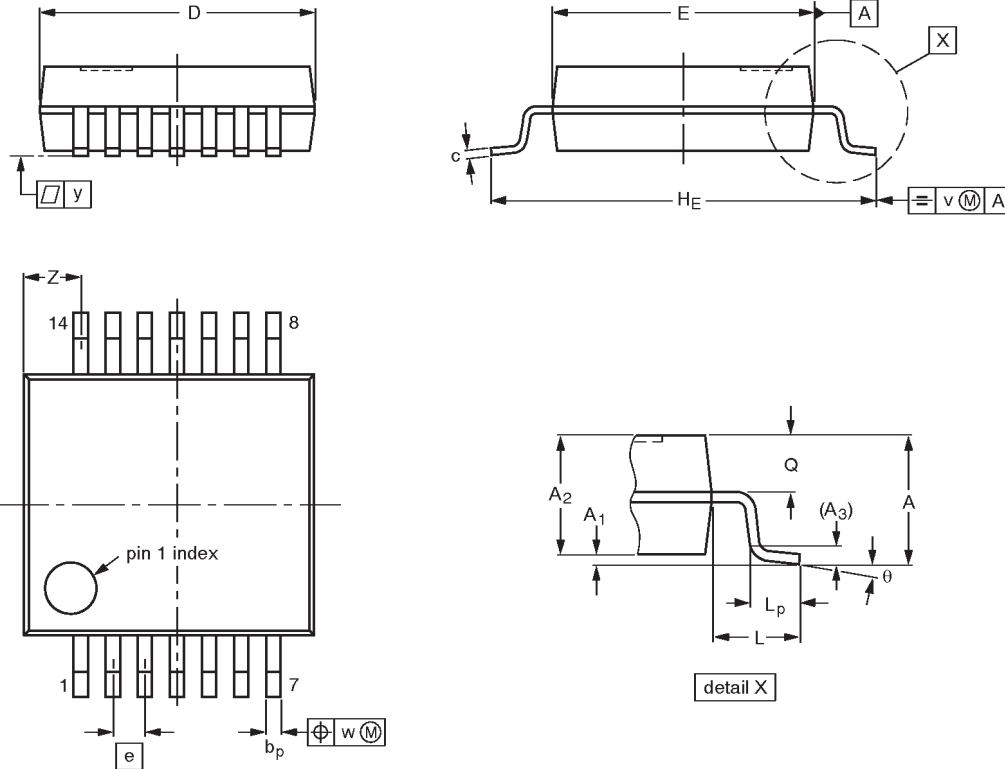
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT108-1	076E06S	MS-012AB				91-08-13 95-01-23

Quad buffer/line driver; (3-state)

74AC125  
74ACT125

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.4 0.9	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

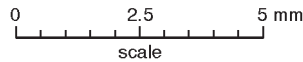
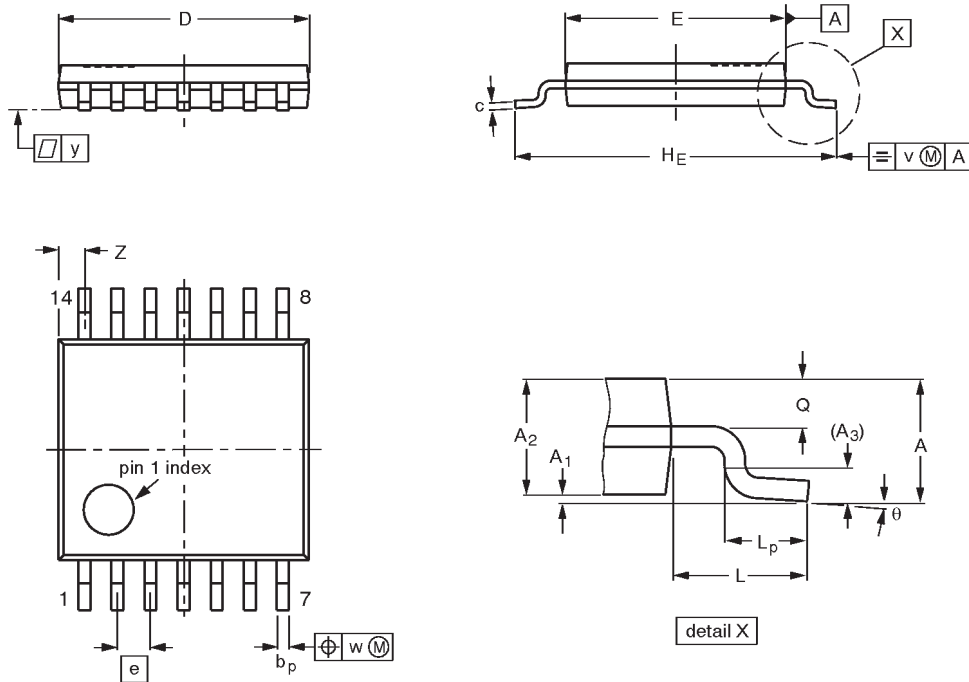
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT337-1		MO-150AB				<del>95-02-04</del> 96-01-18

Quad buffer/line driver; (3-state)

74AC125  
74ACT125

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



**DIMENSIONS (mm are the original dimensions)**

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(2)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

**Notes**

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT402-1		MO-153				-94-07-12- 95-04-04

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Quad buffer/line driver; (3-state)

74AC125  
74ACT125

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**NOTES**

## Quad buffer/line driver (3-state)

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74ACT125

## DEFINITIONS

Data Sheet Identification	Product Status	Definition
<i>Objective Specification</i>	<b>Formative or in Design</b>	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.
<i>Preliminary Specification</i>	<b>Preproduction Product</b>	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
<i>Product Specification</i>	<b>Full Production</b>	This data sheet contains Final Specifications. Philips Semiconductors reserves the right to make changes at any time without notice, in order to improve design and supply the best possible product.

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**Philips Semiconductors**  
**811 East Arques Avenue**  
**P.O. Box 3409**  
**Sunnyvale, California 94088-3409**  
**Telephone 800-234-7381**

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